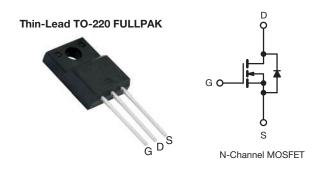


## **E Series Power MOSFET**



PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	70	00
$R_{DS(on)}$ max. ( $\Omega$ ) at 25 °C $V_{GS} = 10$ V		0.6
Q <sub>g</sub> max. (nC)	4	8
Q <sub>gs</sub> (nC)	6	6
Q <sub>gd</sub> (nC)	1	1
Configuration	Sin	gle

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA6N65E-E3
Lead (Pb)-free and halogen-free	SiHA6N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		$V_{DS}$	650	V		
Gate-source voltage		$V_{GS}$	± 30	1 v		
Continuous drain current (T <sub>.1</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1	7		
Continuous drain current (1) = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	5	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	18		
Linear derating factor			0.63	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	56	mJ		
Maximum power dissipation		$P_{D}$	31	W		
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		dV/dt	37	V/ns	
Reverse diode dV/dt <sup>d</sup>			uv/di	27	V/IIS	
Soldering recommendations (peak temperature) c	For	10 s		300	°C	
Mounting torque	Mounting torque M3 screw			0.6	Nm	

- Repetitive rating; pulse width limited by maximum junction temperature  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 2 A 1.6 mm from case

- $I_{SD} \le I_D$ , dl/dt = 100 A/ $\mu$ s, starting  $I_J = 25$  °C Limited by maximum junction temperature



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	43	65	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	3.1	4.0	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				<u>'</u>	l .	_	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zana anta calta na disaisa accument		V <sub>DS</sub> =	650 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 3 A$	-	0.5	0.6	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 3 A	-	2	-	S
Dynamic				•			
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		410	820	1640	pF
Output capacitance	C <sub>oss</sub>	,	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		40	80	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		2	4	8	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V 200 520 V V 200 V		-	36	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0 \	$V_{DS} = 0 \text{ V to } 520 \text{ V}, V_{GS} = 0 \text{ V}$		117	-	
Total gate charge	Qg			-	24	48	
Gate-source charge	$Q_{gs}$	V <sub>GS</sub> = 10 V	$I_D = 3 A, V_{DS} = 520 V$	-	6	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	11	-	
Turn-on delay time	t <sub>d(on)</sub>			-	14	28	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 3 A,		-	12	24	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$= 10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$	-	30	60	ns
Fall time	t <sub>f</sub>		1		20	40	
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.4	1.4	2.7	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the		-	-	7	
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction	<u></u>	-	-	18	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>,J</sub> = 25 °	C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V	-	0.83	1.3	V
Reverse recovery time	t <sub>rr</sub>			118	237	474	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 2$	5 °C, I <sub>F</sub> = I <sub>S</sub> = 3 A, 100 Α/μs <sup>, V</sup> <sub>R</sub> = 25 V	-	2.2	-	μC
Reverse recovery current	I <sub>RRM</sub>	dl/dt = 100 A/μs <sup>, v</sup> <sub>R</sub> = 25 V		_	16	<u> </u>	Α

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

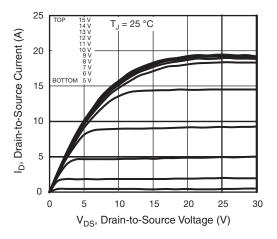


Fig. 1 - Typical Output Characteristics

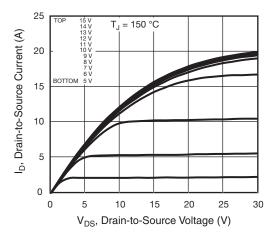


Fig. 2 - Typical Output Characteristics

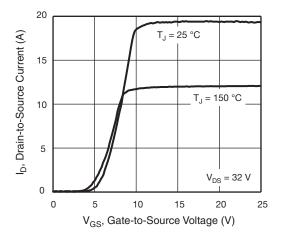


Fig. 3 - Typical Transfer Characteristics

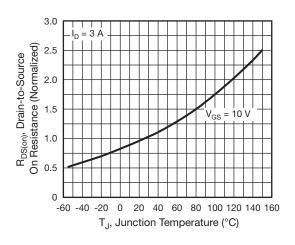


Fig. 4 - Normalized On-Resistance vs. Temperature

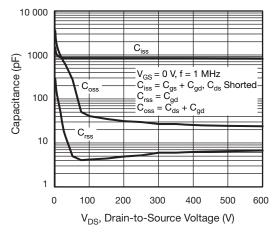


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

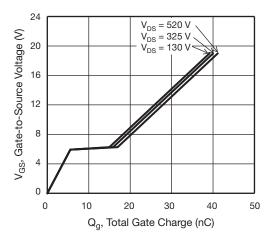


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



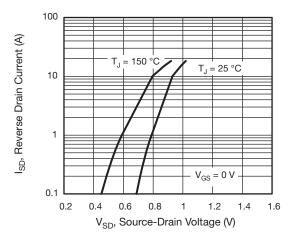


Fig. 7 - Typical Source-Drain Diode Forward Voltage

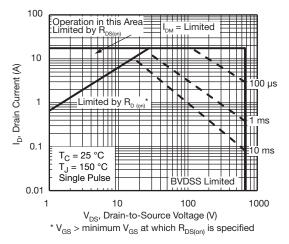


Fig. 8 - Maximum Safe Operating Area

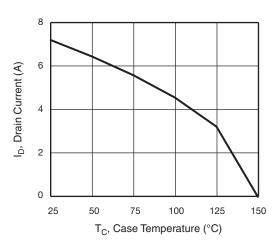


Fig. 9 - Maximum Drain Current vs. Case Temperature

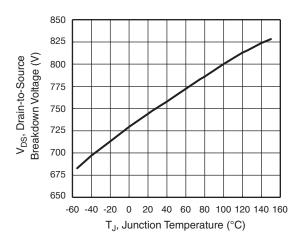


Fig. 10 - Temperature vs. Drain-to-Source Voltage

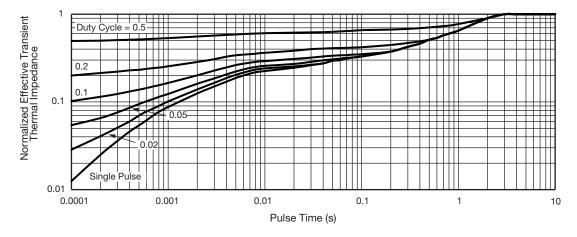


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



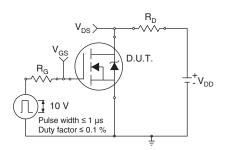


Fig. 12 - Switching Time Test Circuit

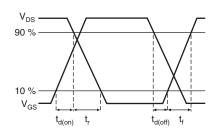


Fig. 13 - Switching Time Waveforms

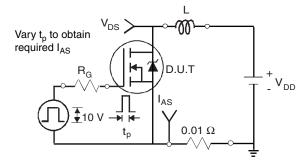


Fig. 14 - Unclamped Inductive Test Circuit

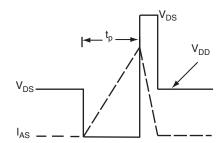


Fig. 15 - Unclamped Inductive Waveforms

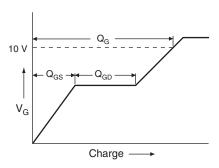


Fig. 16 - Basic Gate Charge Waveform

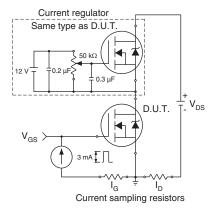
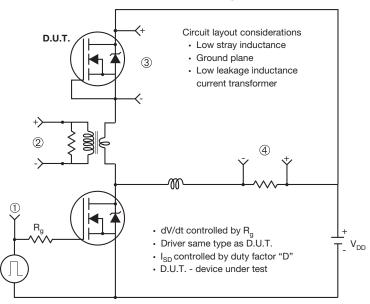


Fig. 17 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



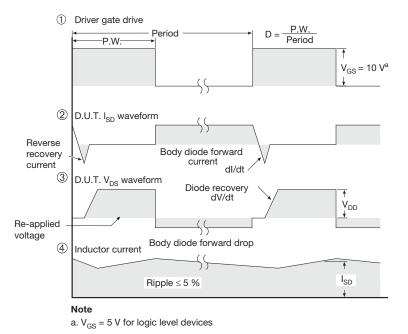
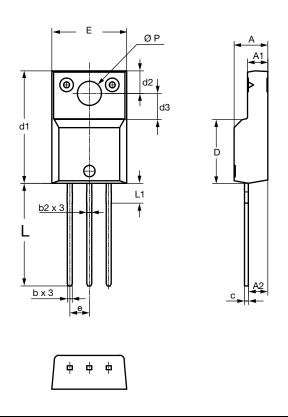


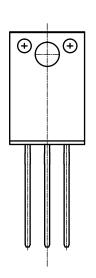
Fig. 18 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL		DIMEN	ISIONS	
	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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